

N-Channel Power MOSFET

1000V, 2.5A, 6Ω

FEATURES

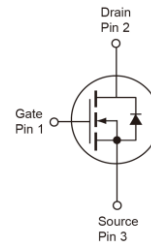
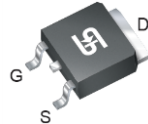
- 100% avalanche tested
- Advanced planar process
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- AC/DC LED Lighting
- Power Supply
- Power Meter

KEY PERFORMANCE PARAMETERS

PARAMETER	VALUE	UNIT
V_{DS}	1000	V
$R_{DS(on)}$ (max)	6	Ω
Q_g	19	nC


TO-252 (DPAK)

Notes: MSL 3 (Moisture Sensitivity Level) per J-STD-020

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	Limit	UNIT
Drain-Source Voltage	V_{DS}	1000	V
Gate-Source Voltage	V_{GS}	±30	V
Continuous Drain Current ^(Note 1)	I_D	$T_C = 25^\circ\text{C}$	A
		$T_C = 100^\circ\text{C}$	
Pulsed Drain Current ^(Note 2)	I_{DM}	10	A
Total Power Dissipation @ $T_C = 25^\circ\text{C}$	P_{DTOT}	99	W
Single Pulse Avalanche Energy ^(Note 3)	E_{AS}	20	mJ
Single Pulse Avalanche Current ^(Note 3)	I_{AS}	1.4	A
Operating Junction and Storage Temperature Range	T_J, T_{STG}	- 55 to +150	°C

THERMAL PERFORMANCE

PARAMETER	SYMBOL	Limit	UNIT
Junction to Case Thermal Resistance	$R_{\theta JC}$	1.26	°C/W
Junction to Ambient Thermal Resistance	$R_{\theta JA}$	62	°C/W

Thermal Performance Note: $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. The case-thermal reference is defined at the solder mounting surface of the drain pins. $R_{\theta JA}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design. $R_{\theta JA}$ shown below for single device operation on FR-4 PCB in still air.

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Static						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	BV_{DSS}	1000	--	--	V
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	$V_{GS(TH)}$	3.5	4.5	5.5	V
Gate Body Leakage	$V_{GS} = \pm 30V, V_{DS} = 0V$	I_{GSS}	--	--	± 100	nA
Zero Gate Voltage Drain Current	$V_{DS} = 1000V, V_{GS} = 0V$	I_{DSS}	--	--	1	μA
Drain-Source On-State Resistance (Note 4)	$V_{GS} = 10V, I_D = 1.25A$	$R_{DS(on)}$	--	5.6	6	Ω
Dynamic (Note 5)						
Total Gate Charge	$V_{DS} = 800V, I_D = 2.5A,$ $V_{GS} = 10V$	Q_g	--	19	--	nC
Gate-Source Charge		Q_{gs}	--	6	--	
Gate-Drain Charge		Q_{gd}	--	10	--	
Input Capacitance	$V_{DS} = 25V, V_{GS} = 0V,$ $f = 1.0MHz$	C_{iss}	--	664	--	pF
Output Capacitance		C_{oss}	--	40	--	
Reverse Transfer Capacitance		C_{rss}		17		
Gate Resistance	$f = 1.0MHz, \text{open drain}$	R_g	--	2.2	--	Ω
Switching (Note 6)						
Turn-On Delay Time	$V_{DD} = 500V, R_G = 25\Omega,$ $I_D = 1.25A, V_{GS} = 10V$	$t_{d(on)}$	--	45	--	ns
Turn-On Rise Time		t_r	--	25	--	
Turn-Off Delay Time		$t_{d(off)}$	--	70	--	
Turn-Off Fall Time		t_f	--	28	--	
Source-Drain Diode						
Forward Voltage (Note 4)	$I_S = 2.5A, V_{GS} = 0V$	V_{SD}	--	--	1.4	V
Reverse Recovery Time	$V_R = 100V, I_S = 2.5A$ $di/dt = 100A/\mu s$	t_{rr}	--	378	--	ns
Reverse Recovery Charge		Q_{rr}	--	1.62	--	μC

Notes:

- Current limited by package
- Pulse width limited by the maximum junction temperature
- $L = 20mH, I_{AS} = 1.4A, V_{DD} = 50V, R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$
- Pulse test: $PW \leq 300\mu s$, duty cycle $\leq 2\%$
- For DESIGN AID ONLY, not subject to production testing.
- Switching time is essentially independent of operating temperature.

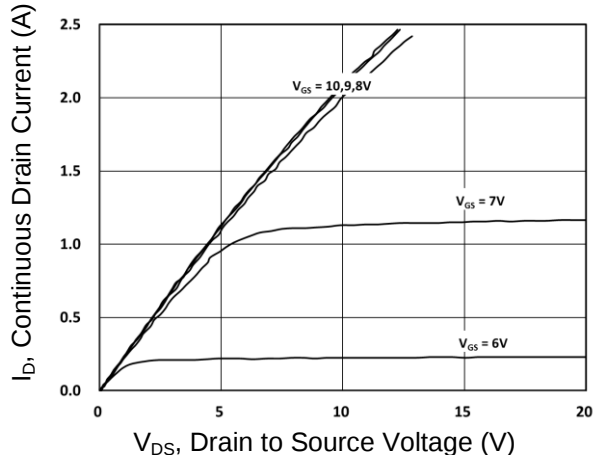
ORDERING INFORMATION

PART NO.	PACKAGE	PACKING
TSM3N100CP ROG	TO-252 (DPAK)	2,500pcs / 13" Reel

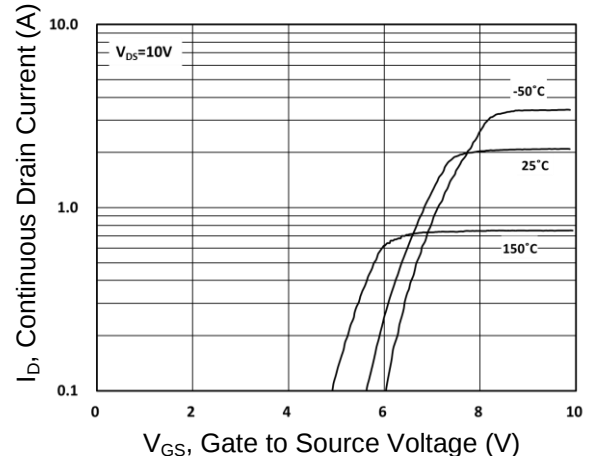
CHARACTERISTICS CURVES

($T_c = 25^\circ\text{C}$ unless otherwise noted)

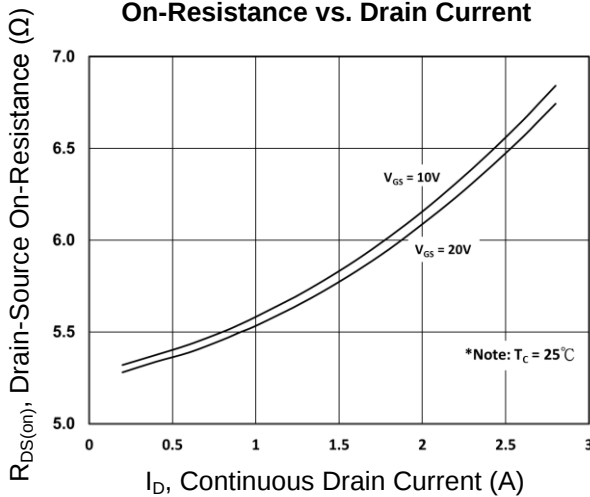
Output Characteristics



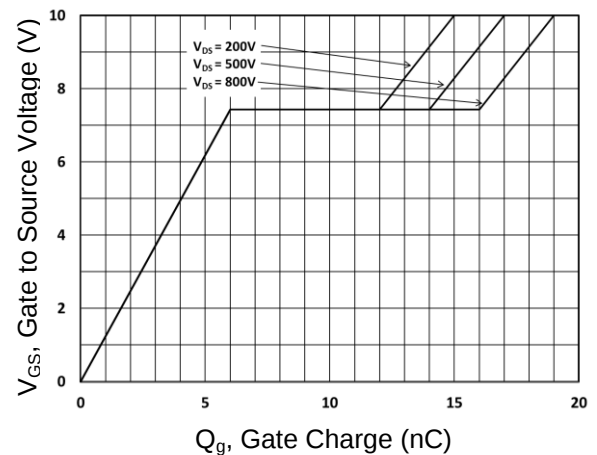
Transfer Characteristics



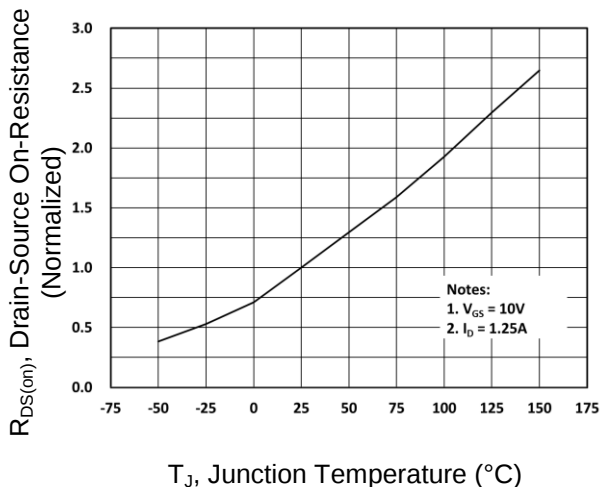
On-Resistance vs. Drain Current



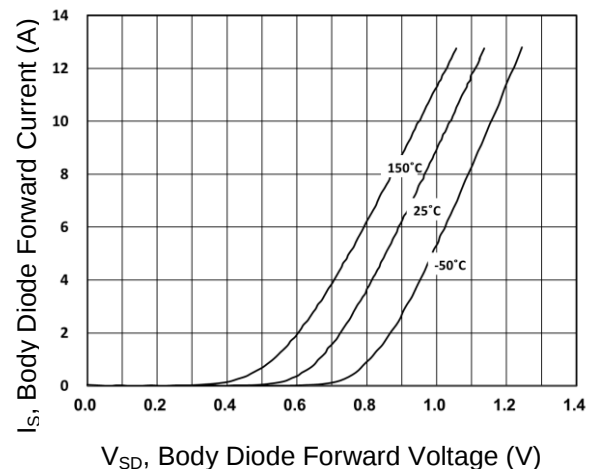
Gate-Source Voltage vs. Gate Charge



On-Resistance vs. Junction Temperature



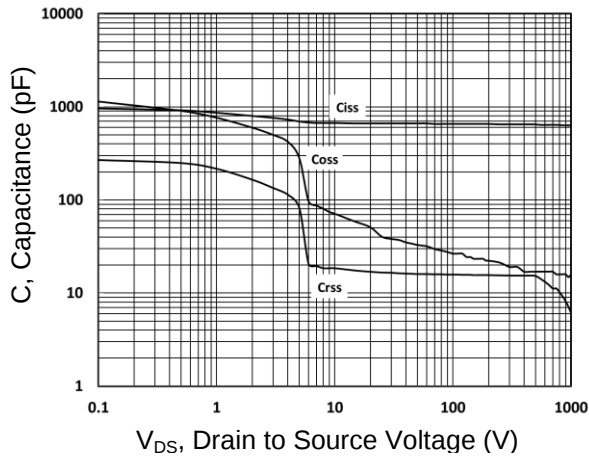
Source-Drain Diode Forward Current vs. Voltage



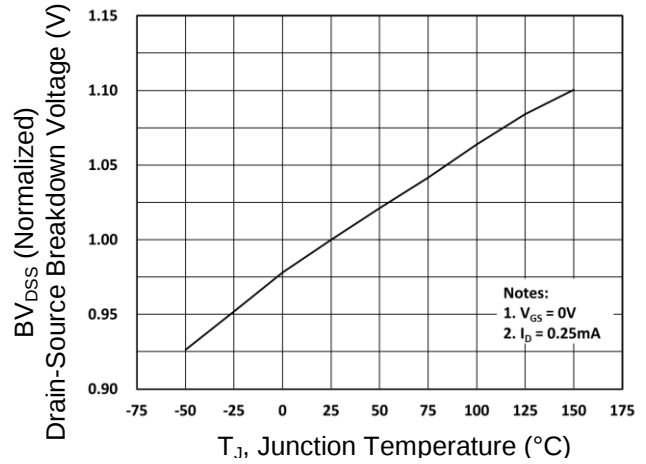
CHARACTERISTICS CURVES

($T_C = 25^\circ\text{C}$ unless otherwise noted)

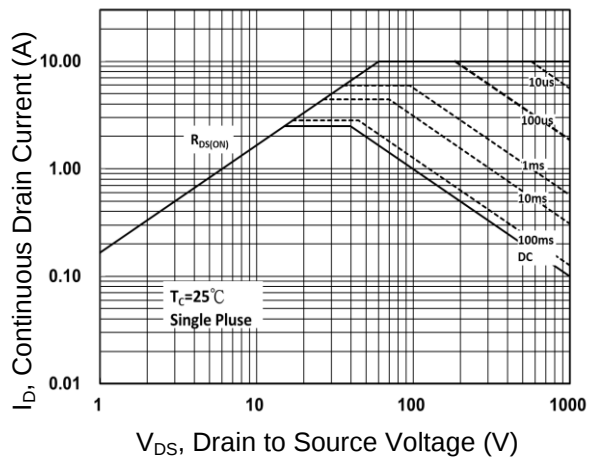
Capacitance vs. Drain-Source Voltage



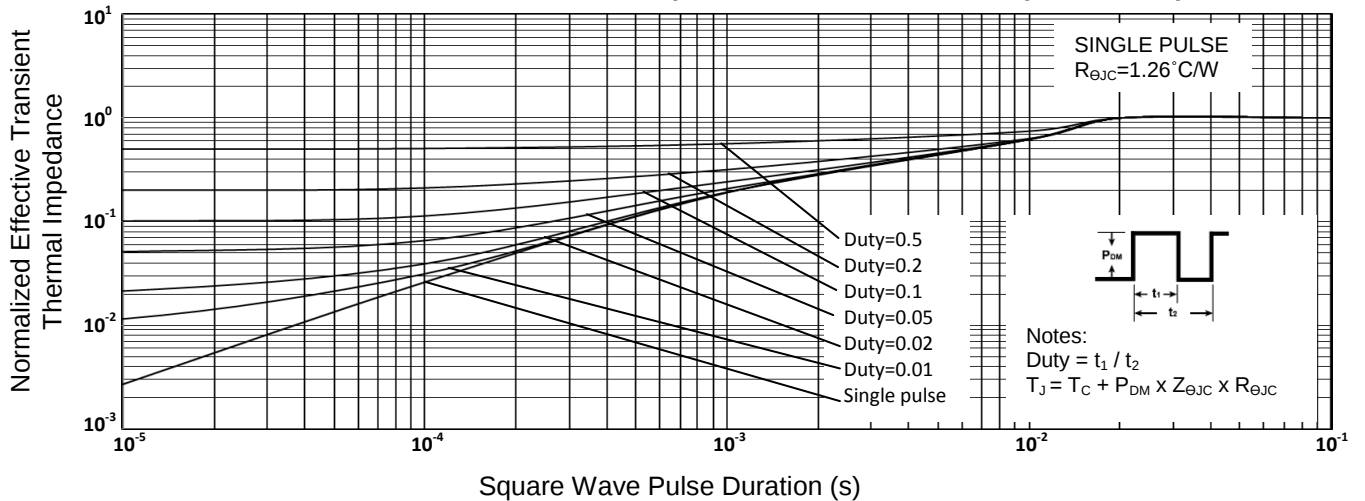
BV_{DSS} vs. Junction Temperature



Maximum Safe Operating Area

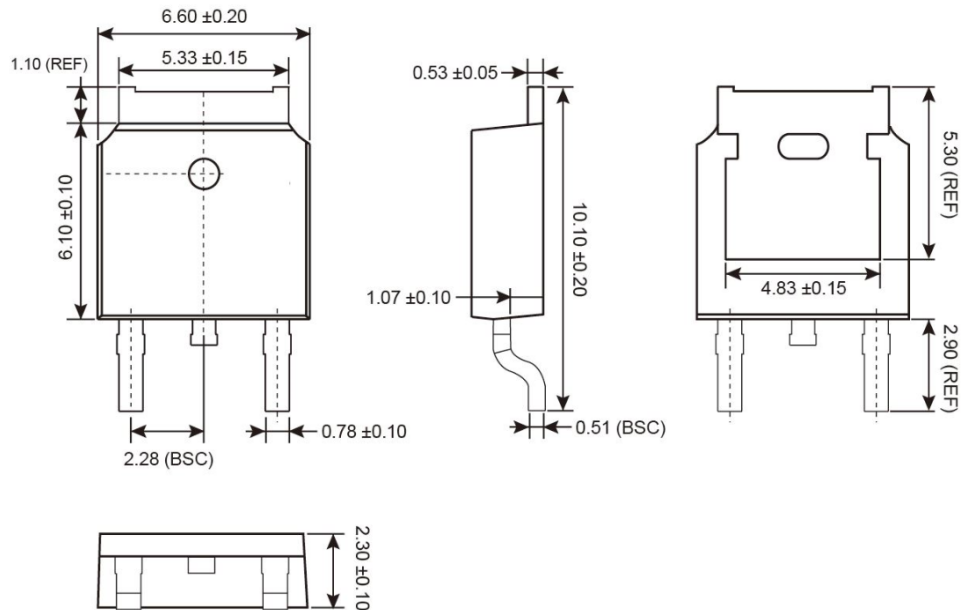


Normalized Thermal Transient Impedance, Junction-to-Case (DPAK/IPAK)

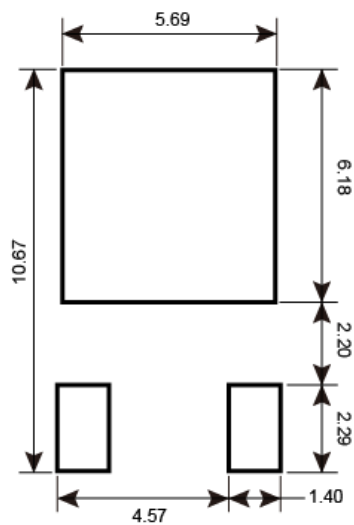


PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

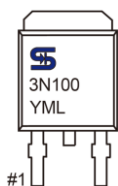
TO-252



SUGGESTED PAD LAYOUT



MARKING DIAGRAM



Y = Year Code
M = Month Code for Halogen Free Product

O =Jan	P =Feb	Q =Mar	R =Apr
S =May	T =Jun	U =Jul	V =Aug
W =Sep	X =Oct	Y =Nov	Z =Dec

L = Lot Code (1~9, A~Z)

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